PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TADASHI YAMAGUCHI	06/25/2018

RECEIVING PARTY DATA

Name:	RENESAS ELECTRONICS CORPORATION	
Street Address:	2-24, TOYOSU 3-CHOME, KOUTOU-KU	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	135-0061	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16107036

CORRESPONDENCE DATA

Fax Number: (202)756-8087

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-756-8000

Email: rfeimster@mwe.com, ipdocketmwe@mwe.com,

wdcipptsclerks@mwe.com

Correspondent Name: TOMOKI TANIDA

Address Line 1: MCDERMOTT WILL & EMERY LLP Address Line 2: 500 NORTH CAPITOL STREET, N.W.

Address Line 4: WASHINGTON, D.C. 20001

ATTORNEY DOCKET NUMBER:	067237-1216	
NAME OF SUBMITTER:	RENELL FEIMSTER FOR TOMOKI TANIDA	
SIGNATURE:	/Renell Feimster for Tomoki Tanida/	
DATE SIGNED:	08/23/2018	

Total Attachments: 2

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> **PATENT REEL: 046678 FRAME: 0166** 505059381

Docket No.: Only After Sept 16, 2012

ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, Renesas Electronics Corporation of 2-24, Toyosu 3-chome, Koutou-ku, Tokyo 135-0061, Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 USC 119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further the assignee. (Legalization not required for recording but is prima facie evidence of execution under 35 USC 261) As the below named inventor, I hereby declare that: This assignment with declaration is X The attached application, or directed to: United States Application or PCT International Application Number filed on The application is entitled: SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREFOR The above identified application was made or was authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed invention in the application. I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted. I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56. I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both. Authorization To Permit Access To Application by Participating Office If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified application is filed access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the application. In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the application-as-filed with respect to: 1) the aboveidentified patent application as-filed, 2) any foreign application to which the above-identified application claims priority under 35 USC 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the aboveidentified patent application, and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Office.

PATENT R170101
REEL: 046678 FRAME: 0167

Legal Name of Inventor Tadashi YAMAGUCHI

Inventor's Signature Tadashi Yawaguchi Date June 25, 2018

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